DARPA pre-baa workshop on Meta-materials September 29, 2000

Applications of Meta-Materials to DoD Electrical Power Systems

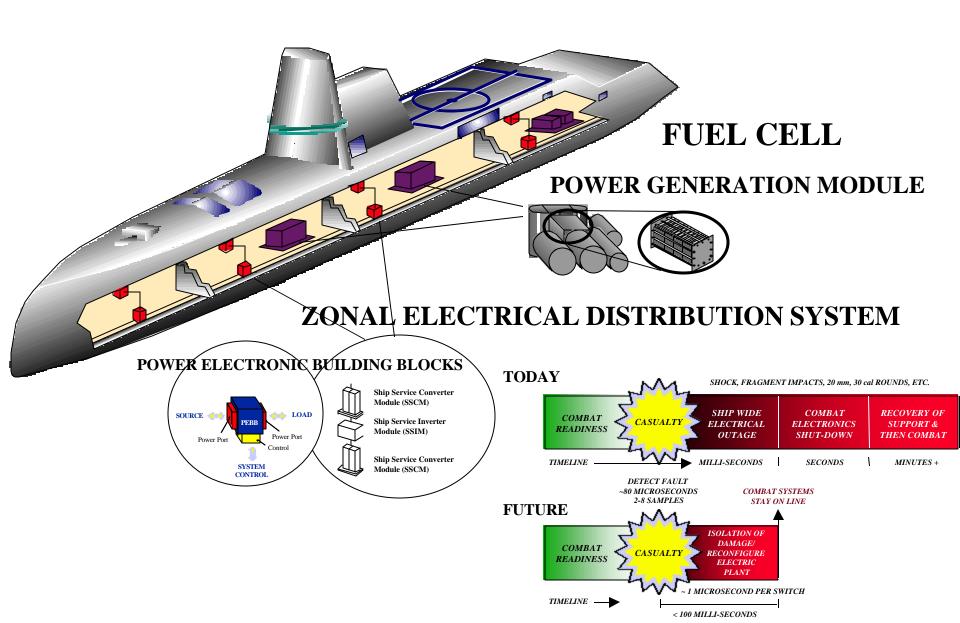
Kristl Hathaway
Office of Naval Research

- •Use of electrical systems in DOD platforms is projected to increase dramatically
- •Power Electronics performance, reliability, and flexibility must improve to meet requirements

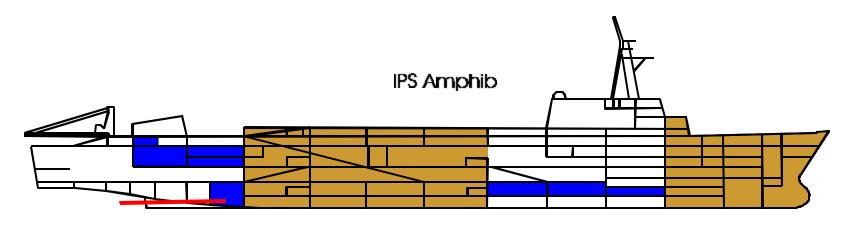
Electric-Drive Ships

- •Reconfigurable
- Increased survivability
- Power balancing
- •Flexibility in ship architecture
- Automation
- •New capabilities:
 - -Electric launch and recovery systems

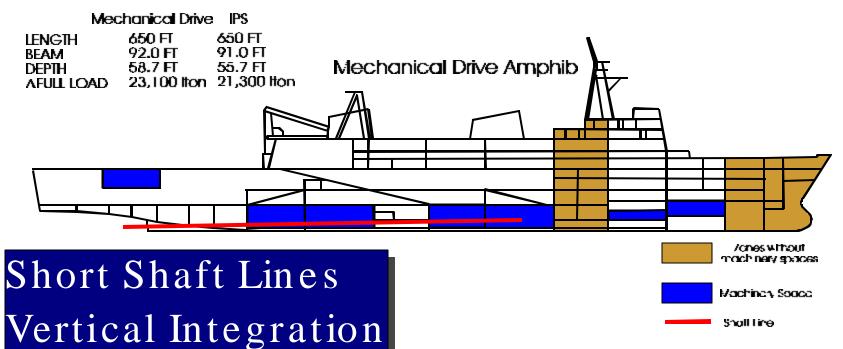
ELECTRICALLY RE-CONFIGURABLE SHIP ENHANCED WARFIGHTING PERFORMANCE



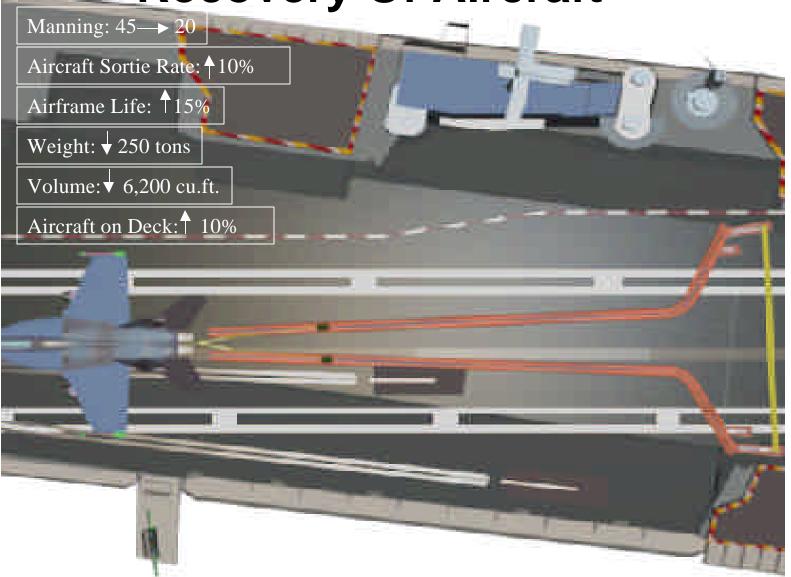
Architectural Flexibility



CHARACTERISTICS



Linear Motor Technology for The Recovery Of Aircraft

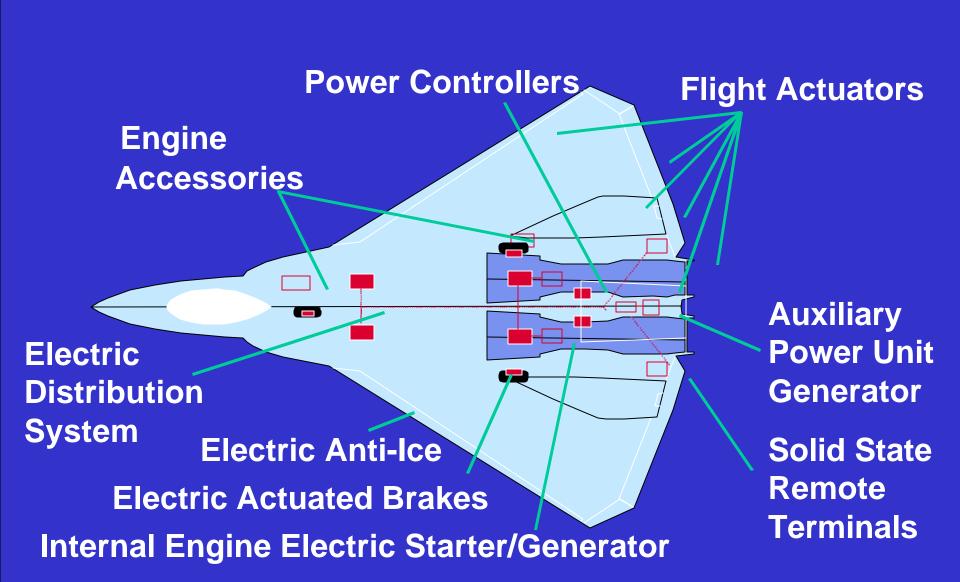


More Flexible Future Aircraft & Ship Designs

More Electric Airplane

- •Survivability
- •No hydraulics, no fluid disposal problems
- •Integrated starter-generator
- •Electric-control actuators

"More Electric Aircraft"



Hybrid-electric ground vehicles

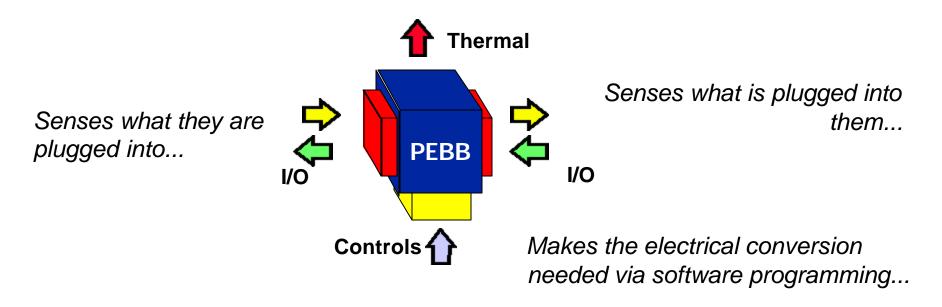
- •Survivability
- Stealth
- •Increased range
- New capabilities
 - -Pulsed power weapons/defenses

Navy Advanced Electrical Power Systems Program

- •Modular architecture (a la microelectronics)
- Standardized interconnects
- •Standardized, programmable controls
- •Reduced cost, improved logistics
- •DC-400 Hz output
- •50kW to MW power
- •20kHz or higher Switching frequency

Power Electronic Building Blocks (PEBB)

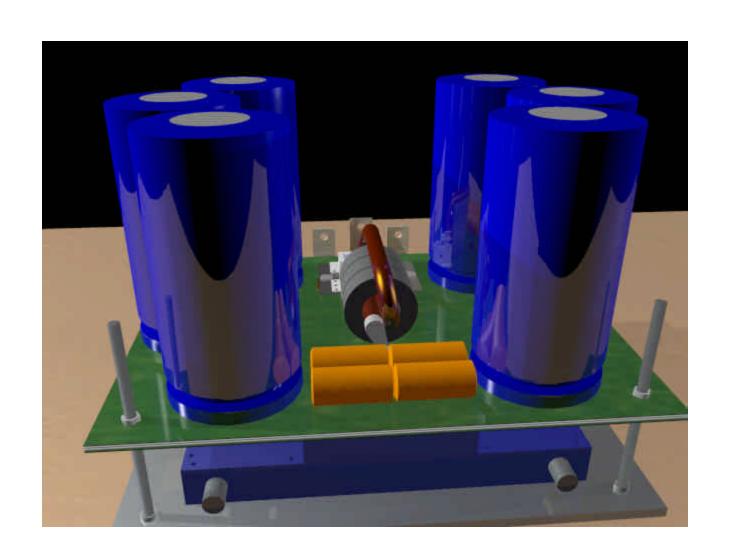
are a set of blocks that:



<u>A UNIVERSAL POWER PROCESSOR</u>. Changes any electrical power input to any desired form of voltage, current and frequency output.

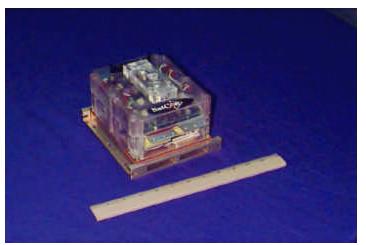
http://pebb.onr.navy.mil

VTB: The Virtual PEBB

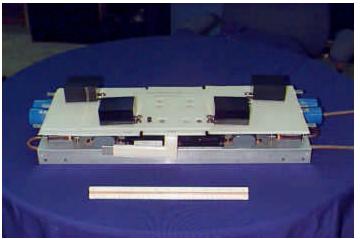


PEBB CONCEPT DEMONSTRATIONS (ALL 3 CONCEPT DEMONSTRATORS EXCEED THE PEBB-3 VOLUMETRIC GOAL OF 50KW/FT³)

50kW, 3-phase inverter by SATCON (~400 kW/ft3 or ~14.1MW/m³)



250kW, single phase leg of a 3-phase multi-level inverter by VPI&SU (200-250 kW/ft³ or 7.1 – 8.8 MW/m3)





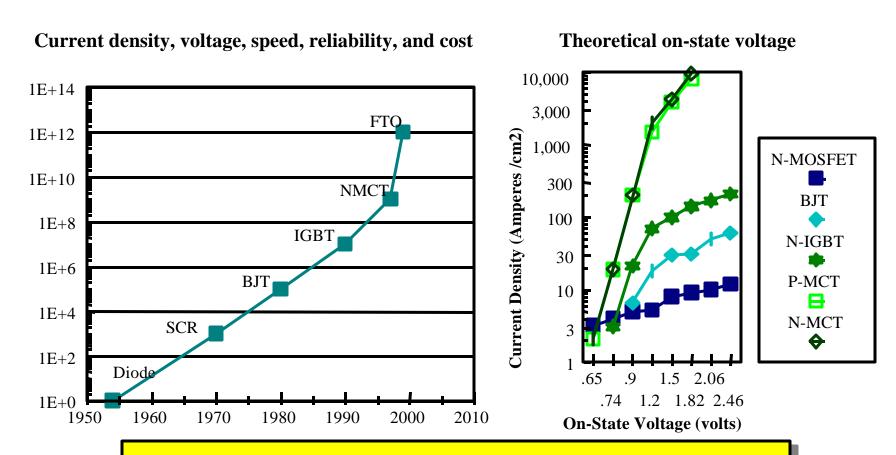
>10x Improvement in size and weight

250kW, single phase leg of a 3-phase inverter by DNSWC/Harris (60 - 80 kW/ft3 or 2.1 – 2.8 MW/m³)

Component technologies for power electronic modules

- Semiconductor switches
- Programmable controller
- •Thermal management, Electrical Isolation and other packaging technologies
- •Input (DC) bus capacitor
- •Resonant capacitor(s) and inductor
- Output (AC) filter capacitor(s) and inductor

TRENDS IN POWER SEMICONDUCTOR DEVICES



7 orders of magnitude over the last 40 years 5 orders of magnitude over the next 5 years

MCT/IGBT solid state switching

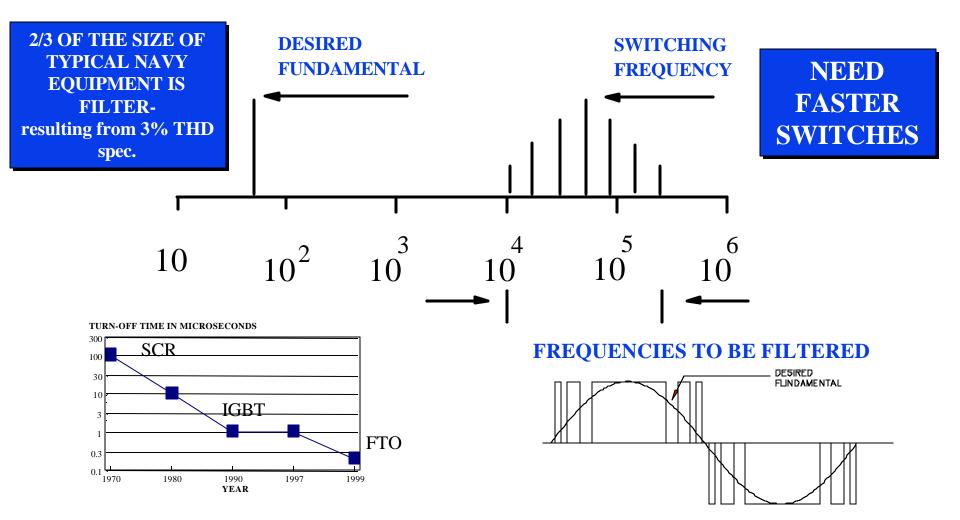
Increased current switching (300 A - IGBT)
Increased voltage (1700 V - IGBT)
Increased frequency (70 kHz - MCT)

Pulse Width Modulation (PWM)

- •Eliminates harmonic distortions noise
- •Clean DC transmission

High Frequency Synthesis

HIGH FREQUENCY = SMALL FILTERS = REDUCED SIZE & WEIGHT HIGH FREQUENCY = MULTI-FUNCTION EQUIPMENT = IMPROVED SYSTEM PERFORMANCE



Capacitors and Inductors

•Input (DC) bus capacitors

- -Counteract switching transients, maintain bus voltage (1000 V)
- -Store energy, could be non-linear
- $-C=4000 \mu F$

Resonant capacitor and inductor

- –Set resonant frequency higher than switching frequency (X10 ideally)
- $-C=1 \mu F, L=1 \mu H$
- -V=1000V, I=800A peak

•Output (AC) filter capacitor and inductor

- -Filter out switching frequency harmonics from output (10 to 400 Hz)
- $-C=50 \mu F$, L=150 μH , nominal
- -V~500V, I~500A

Capacitor Materials Wish List

- •High CV product
- •Linear, stable dielectric curve
- •Smaller size, lighter weight
- •Temperature stability (-55C to 85C)
- •Low ESR, ESL (parasitics)
- •High surge capability -- self-healing

Inductor Material Wish List

- High permeability
- •Linear B-H, non-saturating
- •Zero hysteresis, low losses
- •Light weight, comformable
- Mechanically rugged
- •Temperature stability (-55C to 85C)

Meta-materials for Power Electronics

Combine properties in new ways:

Dielectric or magnetic function +

Thermal conductivity +

Mechanical strength

Provide circuit designers with new options